



QUAD DATA LINE SCHOTTKY BUS TERMINATOR

Features

- Low Forward Voltage Drop
- Fast Switching
- Very High Density
- Ultra-Small Surface Mount Package PN Junction Guard Ring for Transient and ESD Protection
- Provide transient protection for high-speed data lines in accordance with:

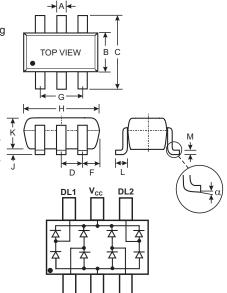
IEC61000-4-2 (ESD) 15kV (Air), 8kV (Contact)

IEC61000-4-4 (EFT) 80A (tp = 5/50 ns) IEC61000-4-5 (Lightning) Class 3

• Lead Free/RoHS Compliant (Note 5)

Mechanical Data

- Case: SOT-363
- Case material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Please See Ordering Information, Note 7, on Page 2
- Polarity: See Diagram
- Marking Code: KST (See Page 2)
- Weight: 0.006 grams (approx.)



GND

| | SOT-363 | | | | | | | | | |
|----------------------|-----------|--------|--|--|--|--|--|--|--|--|
| Dim | Min | Max | | | | | | | | |
| Α | 0.10 | 0.30 | | | | | | | | |
| В | 1.15 | 1.35 | | | | | | | | |
| С | 2.00 | 2.20 | | | | | | | | |
| D | 0.65 N | ominal | | | | | | | | |
| F | 0.30 0.40 | | | | | | | | | |
| Н | 1.80 | 2.20 | | | | | | | | |
| J | _ | 0.10 | | | | | | | | |
| K | 0.90 | 1.00 | | | | | | | | |
| L | 0.25 | 0.40 | | | | | | | | |
| M | 0.10 0.25 | | | | | | | | | |
| α | 0° 8° | | | | | | | | | |
| All Dimensions in mm | | | | | | | | | | |

Maximum Ratings @ T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|--|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 30 | V |
| Forward Continuous Current (Note 1) | I _{FM} | 200 | mA |
| Non-Repetitive Peak Forward Surge Current @ t < 1.0s | I _{FSM} | 600 | mA |
| Power Dissipation (Note 1) | P _d | 200 | mW |
| Thermal Resistance Junction to Ambient Air (Note 1) | $R_{	heta JA}$ | 625 | °C/W |
| Operating Temperature Range | Tj | -55 to +125 | °C |
| Storage Temperature Range | T _{STG} | -65 to +125 | °C |

Electrical Characteristics @ TA = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|--------------------|-----|-------------|----------------------------------|------|---|
| Reverse Breakdown Voltage (Note 2) | V _{(BR)R} | 30 | | _ | V | I _R = 100μA |
| Forward Voltage | V _F | _ | _ | 280 350 450 550 1000 | mV | $\begin{array}{l} I_F = 0.1 \text{mA}, \ tp < 300 \mu S \\ I_F = 1.0 \text{mA}, \ tp < 300 \mu S \\ I_F = 10 \text{mA}, \ tp < 300 \mu S \\ I_F = 30 \text{mA}, \ tp < 300 \mu S \\ I_F = 100 \text{mA}, \ tp < 300 \mu S \\ \end{array}$ |
| Reverse Current (Note 2) | I _R | _ | _ | 2 | μΑ | V _R = 25V |
| Total Capacitance | СТ | _ | 10.0 6.5 | _ | pF | V _R = 0, f = 1.0MHz (Note 3) V _R = 0, f = 1.0MH _Z (Note 4) |
| Reverse Recovery Time | t _{rr} | _ | _ | 5.0 | ns | $I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$ |

Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

- 2. Short duration test pulse used to minimize self-heating effect.
- 3. At $V_R = 0V$, DL(X) to V_{CC} or GND.
- 4. At $V_R = 0V$, between Data Lines (e.g., DL1 and DL4).
- 5. No purposefully added lead.

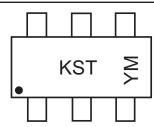


Ordering Information (Note 6)

| Device | Packaging | Shipping |
|------------|-----------|------------------|
| QSBT40-7-F | SOT-363 | 3000/Tape & Reel |

Notes: 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



KST = Product Type Marking Code YM = Date Code Marking

Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

| Year | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 |
|------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | М | N | Р | R | S | Т | U | V | W | Х | Υ | Z |

| Month | Jan | Feb | March | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

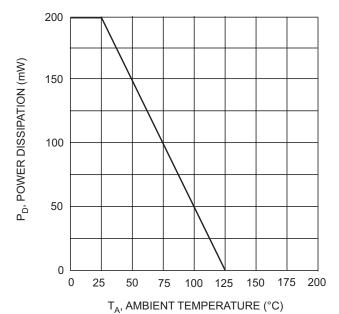


Fig. 1, Max Power Dissipation vs Ambient Temperature



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